

Hi3531D V100 H.265 CODEC Processor

Brief Data Sheet

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HiSilicon Technologies Co., Ltd.

Address: Huawei Industrial Base

> Bantian, Longgang Shenzhen 518129

People's Republic of China

Website: http://www.hisilicon.com

Email: support@hisilicon.com



Key Specifications

Processor Core

- Dual-core ARM Cortex A9@1.4 GHz
 - 32 KB L1 I-cache, 32 KB L1 D-cache
 - 256 KB L2 cache
 - NEON and FPU

Video Encoding/Decoding Protocols

- H.265 Main Profile, Level 5.0 encoding
- H.265 Main Profile, Level 5.1 decoding
- H.264 Baseline/Main/High Profile, Level 5.1 encoding
- H.264 Baseline/Main/High Profile, Level 5.2 decoding
- MPEG-4 SP, L0–L3/ASP L0–L5 decoding
- MJPEG/JPEG baseline

Video Encoding/Decoding

- H.265/H.264&JPEG multi-stream encoding and decoding
 - 8x1080p@30 fps H.265/H.264 encoding+8xD1@30 fps H.265/H.264 encoding+8x1080p@30 fps H.265/H.264 decoding+8x1080p@2 fps JPEG encoding
 - 16x720p@30 fps H.265/H.264 encoding+16xD1@30 fps H.265/H.264 encoding+16x720p@30 fps H.265/H.264 decoding+16x720p@2 fps JPEG encoding
 - 32x960H@30 fps H.265/H.264 encoding+32xCIF@30 fps H.265/H.264 encoding+16x960H@30 fps H.265/H.264 decoding+32x960H@2 fps JPEG encoding
- Constant bit rate (CBR) mode, variable bit rate (VBR) mode, FIXQP mode, adaptive variable bit rate (AVBR) mode, and QpMap mode
- Maximum 40 Mbit/s output bit rate
- ROI encoding
- Color-to-gray encoding

Intelligent Video Analysis

 Integrated IVE, supporting various intelligent analysis applications such as motion detection, perimeter defense, and video diagnosis

Video and Graphics Processing

- Video pre- and post-processing, including deinterlacing, sharpening, 3D denoising, DCI, and demosaic
- Anti-flicker for output videos and graphics
- 1/15x to 16x video scaling
- 1/2x to 2x graphics scaling
- Four Cover regions
- OSD overlaying of eight regions

Audio Encoding/Decoding

- ADPCM, G.711, and G.726 hardware audio encoding
- Software audio encoding and decoding complying with multiple protocols

Security Engine

 AES, DES, and 3DES algorithms implemented by using hardware

Video Interfaces

- VI interfaces
 - Eight 8-bit interfaces and one 16-bit video cascade interface
 - Two 8-bit interfaces that can form a 16-bit interface
 - 108 MHz/144 MHz 4xD1/960H TDM inputs for each 8bit interface (32xD1/32x960H real-time video inputs in total)
 - 144 MHz/148.5 MHz 2x720p TDM inputs for each 8-bit interface (16x720p@30 fps real-time video inputs in total)
 - 4x720p TDM inputs through 148.5 MHz dual-edge sampling or 297 MHz single-edge sampling for each 8bit interface (32x720p@30 fps real-time video inputs in total)
 - 148.5 MHz BT.1120 inputs in Y/C interleaved mode for each 8-bit interface (8x1080p@30 fps real-time video inputs in total)
 - 2x1080p TDM inputs through 148.5 MHz dual-edge sampling or 297 MHz single-edge sampling for each 8-bit interface (16x1080p@30 fps real-time video inputs in total)
 - 1x4M (2560 x 1440) TDM inputs through 148.5 MHz dual-edge sampling or 297 MHz single-edge sampling for each 8-bit interface (8x4M@30 fps real-time video inputs in total)
 - 148.5 MHz BT.1120 standard mode for each 16-bit interface (4x1080p@60 fps real-time video inputs in total)
 - 1x 3840 x 2160@30 fps input through 148.5 MHz dualedge sampling for the 16-bit video cascade input interface
- VO interfaces
 - One HDMI 2.0 output interface with the maximum output of 3840 x 2160@60 fps
 - One VGA HD output interface with the maximum output of 2560 x 1600@60 fps
 - One BT.1120 HD output interface with the maximum output of 1080p@60 fps
 - One BT.1120 video cascade output interface with the maximum output of 3840 x 2160@30 fps
 - Two independent HD output channels (DHD0 and DHD1), output over any HD interface (HDMI, VGA, or BT.1120/ Cascade Interface)
 - 64-picture output for DHD0, maximum output of 3840
 x 2160@60 fps
 - 64-picture output for DHD1, maximum output of 1080p@60 fps
 - One CVBS SD output interface
 - Three full-screen GUI graphics layers in ARGB1555 or ARGB8888 format for two HD channels and one SD channel
 - Two hardware cursor layers in ARGB1555 or ARGB8888 format (configurable) with the maximum



resolution of 256 x 256

Audio Interfaces

- Five unidirectional I²S/PCM interfaces
 - Three input interfaces, supporting 20 multiplexed inputs
 - Two output interfaces, supporting dual-channel outputs
 - 16-bit audio inputs and outputs

Ethernet Ports

- One gigabit Ethernet port
 - RGMII, RMII, and MII modes
 - 10/100 Mbit/s half-duplex or full-duplex
 - 1000 Mbit/s full-duplex
 - TSO for reducing the CPU usage

Peripheral Interfaces

- Four SATA 3.0/PCIe 2.0/USB 3.0 multiplexed interfaces
 - Configurable four SATA interfaces, two SATA interfaces+two 1-lane PCIe interfaces, or one USB 3.0 interface+two SATA interfaces+one 1-lane PCIe interface
 - RC and EP supported as the PCIe 2.0 interface
 - eSATA and PM supported as the SATA 3.0 interface
 - USB host and hub supported as the USB 3.0 interface
- Two USB 2.0 host interfaces, supporting the hub
- Four UART interfaces (including two 4-wire interfaces)
- One SPI, supporting four CSs
- One IR interface
- Two I²C interface
- Multiple GPIO interfaces

Memory Interfaces

- Two 32-bit DDR3 SDRAM interfaces
 - Dual channels
 - ODT
 - Maximum capacity of 3 GB
- NAND flash interface
 - 8-bit NAND flash
 - Two CSs
 - SLC or MLC
 - 8-/24-/40-/64-bit ECC (based on 1 KB data block)
- SPI NOR/NAND flash interface
 - 1-/2-/4-wire SPI NOR/NAND flash

- Two CSs, connected to different types of flash memories
- Maximum capacity of 64 MB for each CS (for the SPI NOR flash)
- Maximum capacity of 512 MB for each CS (for the SPI NAND flash)
- 2 KB/4 KB page size (for the SPI NAND flash)
- 8-bit/1 KB or 24-bit/1 KB ECC (for the SPI NAND flash)
- Embedded 4 KB BOOTROM and 64 KB SRAM

RTC with an Independent Power Supply

• Independent battery for supplying power to the RTC

Configurable Boot Modes

- Booting from the BOOTROM
- Booting from the SPI NOR flash
- Booting from the SPI NAND flash
- Booting from the NAND flash
- Booting the slave chip over the PCIe interface

SDK

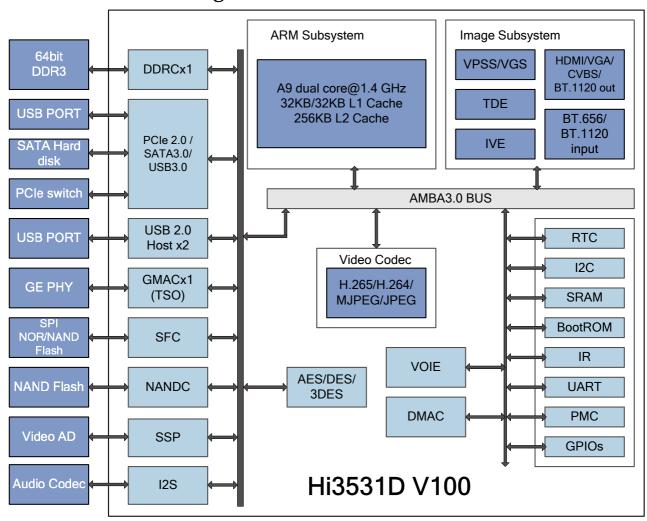
- Linux 3.18-based SDK
- Audio encoding and decoding libraries complying with multiple protocols
 - High-performance H.265/H.264 PC decoding library

Physical Specifications

- Power consumption
 - Typical power consumption of 5 W
 - Multi-level power consumption control
- Operating voltages
 - 0.9 V core voltage
 - 1.0 V CPU voltage
 - -3.3 V I/O voltage
 - 1.5 V voltage for the DDR3 SDRAM interface
- Package
 - RoHS, EDHS-PBGA
 - Ball pitch of 0.8 mm (0.03 in.)
 - Body size of 27 mm x 27 mm (1.06 in. x 1.06 in.)
- Operating temperature ranging from 0°C (32°F) to 70°C (158°F)



Functional Block Diagram



The Hi3531D V100 is a professional SoC targeted for multi-channel HD (1080p/720p) or SD (D1/960H) DVRs. The Hi3531D V100 provides an embedded dual-core ARM A9 processor, a high-performance H.265 video encoding/decoding engine, a high-performance video/graphics processing engine integrated with various complicated graphics processing algorithms, HDMI/VGA HD outputs, and various peripheral interfaces. These features enable the Hi3531D V100 to provide high-performance, high-picture-quality, and low-cost analog HD/SDI solutions for customers' products while greatly reducing the eBOM cost.

DVRs (Each with a Hi3531D V100)

8x1080p DVR

- 8x1080p@30 fps H.265/H.264 encoding+8xD1@30 fps H.265/H.264 encoding+8x1080p@30 fps H.265/H.264 decoding+8x1080p@2 fps JPEG encoding
- HDMI 4K x 2K@30 fps output

16x720p DVR

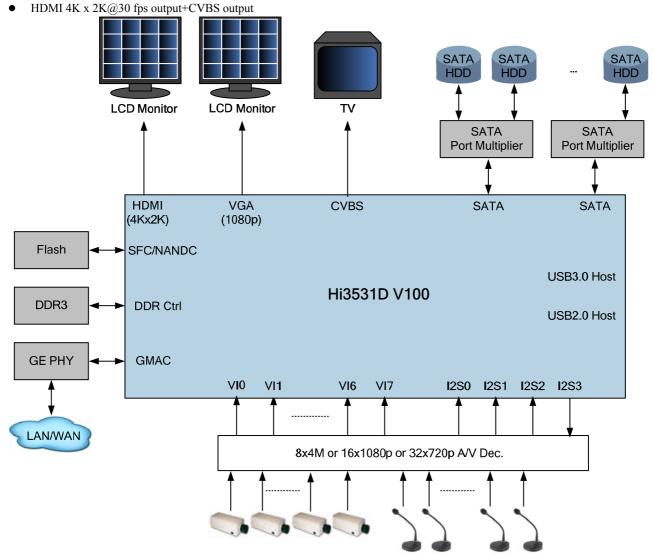
• 16x720p@30 fps H.265/H.264 encoding+16xD1@30 fps H.265/H.264 encoding+16x720p@30 fps H.265/H.264 decoding+16x720p@2 fps JPEG encoding



HDMI 4K x 2K@30 fps output

32x960H DVR

- 32x960H@30 fps H.265/H.264 encoding+32xCIF@30 fps H.265/H.264 encoding+16x960H@30 fps H.265/H.264
- decoding+32x960H@2 fps JPEG encoding





Acronyms and Abbreviations

3DES triple data encryption standard

ADPCM adaptive differential pulse code modulation

AES advanced encryption standard

CBR constant bit rate
CODEC coder/decoder
CS chip select

CVBS composite video broadcast signal DCI dynamic contrast improvement

DDR double data rate

DES data encryption standard
DVR digital video recorder
eBOM engineering bill of materials
ECC error correcting code

EDHS-PBGA exposed drop-in heat sink plastic ball grid array

EP end point

eSATA external serial advanced technology attachment

GPIO general-purpose input/output GUI graphical user interface

HD high definition

HDMI high definition multimedia interface

 I^2C inter-integrated circuit I^2S inter-IC sound IR infrared

IVE intelligent video engine
MII media independent interface

MLC multi-level cell
ODT on-die termination
OSD on-screen display

PCIe peripheral component interconnect express

PCM pulse code modulation PM port multiplexer QP quantization parameter

RC root complex

RGMII reduced gigabit media independent interface
RMII reduced media independent interface
RoHS Restriction of Hazardous Substances

ROI region of interest RTC real-time clock

SATA serial advanced technology attachment

SD standard definition
SDI serial digital interface
SDK software development kit

SDR single data rate

SDRAM synchronous dynamic random access memory

SLC single-level cell SoC system-on-chip

SPI serial peripheral interface
SRAM static random access memory
TDM time division multiplexing
TSO TCP segmentation offload

UART universal asynchronous receiver transmitter



VBR variable bit rate
VGA video graphics array

VI video input VO video output